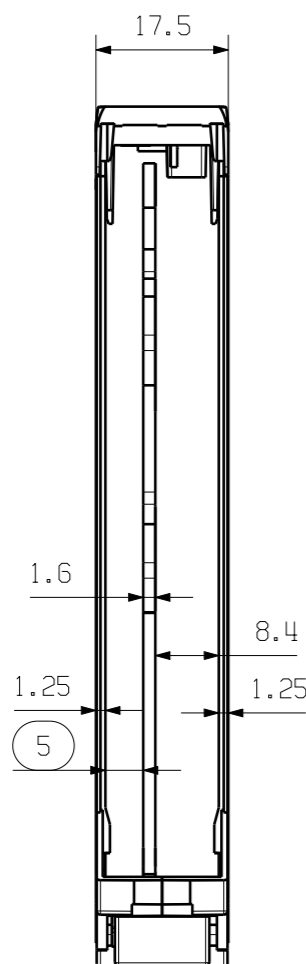
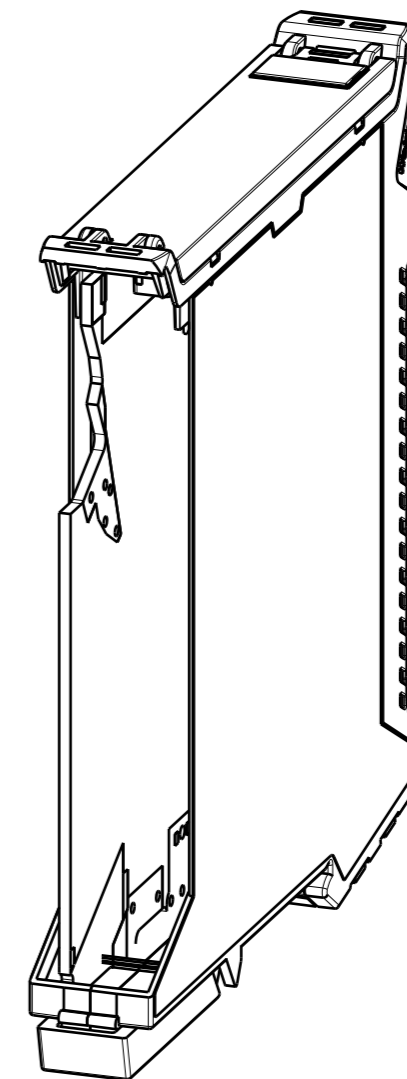


Abstand Gehäusewand zur LP:
Distance moulding wall to PCB: **2.3mm**
Darstellung der Position der Stiftleisten siehe (Z.-Nr.): CH20M A OV PCB-SHL (70315)
Representation of the position of the pin headers see (d.no.): CH20M A OV PCB-SHL (70315)



Abstand Gehäusewand zur LP:
Distance moulding wall to PCB: **5.0mm**
Darstellung der Position der Stiftleisten siehe (Z.-Nr.): CH20M A OV PCB-SHL (70315)
Representation of the position of the pin headers see (d.no.): CH20M A OV PCB-SHL (70315)

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EC00004186	Prim PLM Part No.: 1159374	Prim ERP Part No.:
First Issue Date 28.06.2019	Max. nos.	
	Modification	
	Drawn	70149 Drawing no. Issue no. 1 Sheet 01 of 01 sheets
	Responsible	
	Approved	
Scale: 1/1	Size: A3	LP-POSITION 17MM LEITERPLATTEN-POSITION PCB POSITION
Drawings Customer	Product file: 5670 CH20...	